

2N2222A

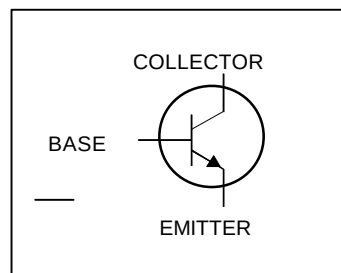
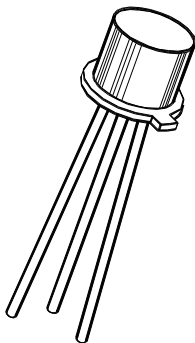
Features

- Meets MIL 19500 /255
- Collector - Base Voltage 75 V
- Collector - Current 800 mA
- High Speed, Medium Current Bipolar Transistor

**SWITCHING
TRANSISTOR
JAN, JANTX, JANTXV**

**SMALL SIGNAL
BIPOLAR
NPN SILICON**

TO-18



Maximum Ratings

RATING	SYMBOL	VALUE	UNIT
Collector - Emitter Voltage	V_{CEO}	50	Vdc
Collector - Base Voltage	V_{CBO}	75	Vdc
Emitter - Base Voltage	V_{EBO}	6	Vdc
Collector Current -- Continuous	I_C	800	mAdc
Total Device Dissipation @ $T_A = 25\text{ }^{\circ}\text{C}$	P_D	500	mW
Derate above 25 $^{\circ}\text{C}$		2.85	mW/ $^{\circ}\text{C}$
Total Device Dissipation @ $T_C = 25\text{ }^{\circ}\text{C}$	P_D	1.8	WATTS
Derate above 25 $^{\circ}\text{C}$		10.3	mW/ $^{\circ}\text{C}$
Operating Junction&Storage Temperature Range	T_J, T_{stg}	- 65 to + 200	$^{\circ}\text{C}$

Thermal Characteristics

CHARACTERISTIC	SYMBOL	MAX	UNIT
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	350	$^{\circ}\text{C/W}$

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

OFF CHARACTERISTIC	SYMBOL	MIN	MAX	UNIT
Collector - Emitter Breakdown Voltage (1)	$V(\text{BR})_{\text{CEO}}$			
($I_C = 10 \text{ mA dc}, I_B = 0$)		50		Vdc
Collector - Base Breakdown Voltage (1)	$V(\text{BR})_{\text{CBO}}$			
($I_C = 10 \text{ mAdc}, I_E = 0$)		75		Vdc
Emitter - Base Breakdown Voltage (1)	$V(\text{BR})_{\text{EBO}}$			
($I_E = 10 \text{ mAdc}, I_C = 0$)		6		Vdc
Collector - Emitter Cutoff Current	I_{CES}			
($V_{\text{CE}} = 50 \text{ Vdc}, V_{\text{BE(off)}} = 0 \text{ V}$)			50	nAdc
Collector - Base Cutoff Current	I_{CBO}			
($V_{\text{CB}} = 60 \text{ Vdc}, I_E = 0$)			10	nAdc
($V_{\text{CB}} = 60 \text{ Vdc}, I_E = 0, T_A = 150^\circ\text{C}$)			10	mAdc
Emitter - Base Cutoff Current	I_{EBO}			
($V_{\text{EB}} = 4 \text{ Vdc}$)			10	nAdc

ON CHARACTERISTIC	SYMBOL	MIN	MAX	UNIT
DC Current Gain	h_{FE}			
($I_C = 100 \text{ mA dc}, V_{\text{CE}} = 10 \text{ Vdc}$)		50		
($I_C = 1 \text{ mA dc}, V_{\text{CE}} = 10 \text{ Vdc}$)		75	325	
($I_C = 10 \text{ mA dc}, V_{\text{CE}} = 10 \text{ Vdc}$)		100		
($I_C = 150 \text{ mA dc}, V_{\text{CE}} = 10 \text{ Vdc}$) (1)		100	300	
($I_C = 500 \text{ mA dc}, V_{\text{CE}} = 10 \text{ Vdc}$) (1)		30		
($I_C = 10 \text{ mA dc}, V_{\text{CE}} = 10 \text{ Vdc}, T_J = -55^\circ\text{C}$)		35		
Collector - Emitter Saturation Voltage	$V_{\text{CE(sat)}}$			
($I_C = 150 \text{ mAdc}, I_B = 15 \text{ mAdc}$) (1)			0.3	Vdc
($I_C = 500 \text{ mAdc}, I_B = 50 \text{ mAdc}$) (1)			1.0	Vdc
Base - Emitter Saturation Voltage	$V_{\text{BE(sat)}}$			
($I_C = 150 \text{ mAdc}, I_B = 15 \text{ mAdc}$) (1)		0.6	1.2	Vdc
($I_C = 500 \text{ mAdc}, I_B = 50 \text{ mAdc}$) (1)			2.0	Vdc

1. Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

SMALL - SIGNAL CHARACTERISTICS	SYMBOL	MIN	MAX	UNIT
Output Capacitance ($V_{CB} = 10\text{ Vdc}$, $I_E = 0$, $100\text{kHz} \leq f \leq 1\text{ MHz}$)	C_{obo}		8	pF
Input Capacitance ($V_{EB} = 0.5\text{ Vdc}$, $I_C = 0$, $100\text{kHz} \leq f \leq 1\text{ MHz}$)	C_{ibo}		25	pF

SWITCHING CHARACTERISTICS	SYMBOL	MIN	MAX	UNIT
Turn - On Time ($V_{CC} = 30\text{ Vdc}$, $I_C = 150\text{ mAdc}$, $I_{B1} = 15\text{ mAdc}$) (See FIGURE 1)	t_{on}		35	ns
Turn - Off Time ($V_{CC} = 30\text{ Vdc}$, $I_C = 150\text{ mAdc}$, $I_{B1} = -I_{B2} = 15\text{ mAdc}$) (See FIGURE 2)	t_{off}		300	ns

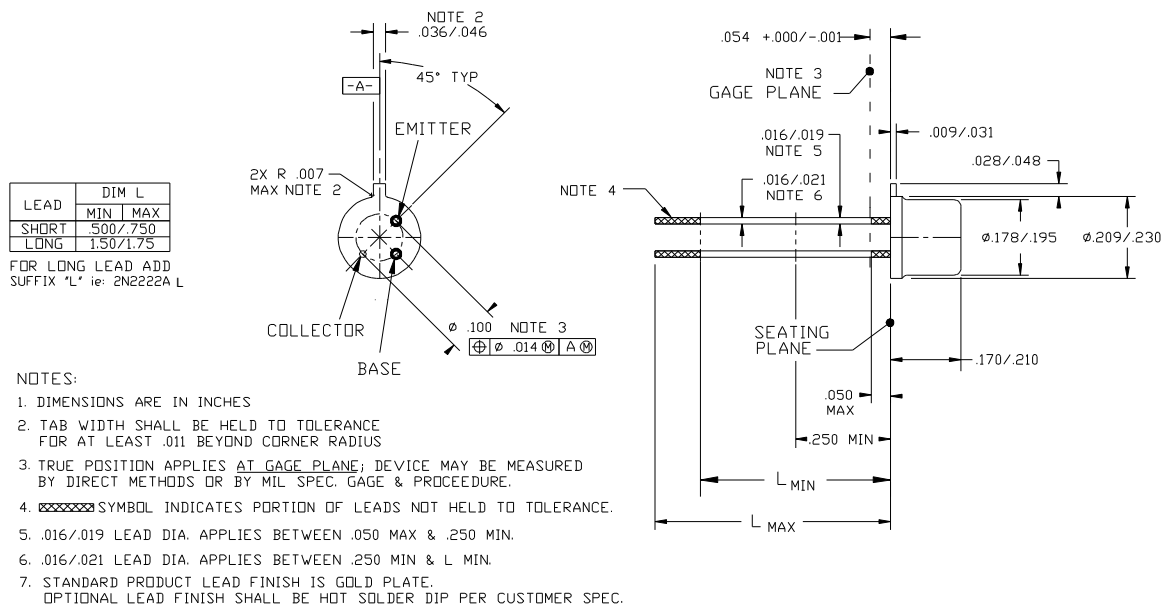
Small - Signal AC Characteristics ($T_A = 25^\circ\text{C}$)

LOW FREQUENCY	SYMBOL	MIN	MAX	UNIT
Common - Emitter Forward Current Transfer Ratio ($I_C = 1\text{ mA}$, $V_{CE} = 10\text{ V}$, $f = 1\text{ kHz}$)	h_{fe}	50		
HIGH FREQUENCY				
Common - Emitter Forward Current Transfer Ratio ($I_C = 20\text{ mA}$, $V_{CE} = 20\text{ V}$, $f = 100\text{ MHz}$)	$ h_{fe} $	2.5		

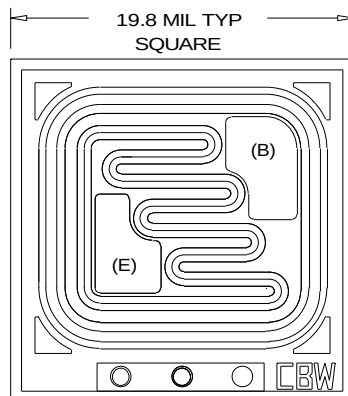
Spice Model (based upon typical device characteristics) ^{*1}

Q2N2222A NPN ($I_S = 19.34\text{ n}$ $XT = 3.0$ $EG = 1.11$ $VA_F = 250.3$ $BF = 163.8$ $ISE = 174.3\text{ f}$
 + $NE = 1.647$ $IKF = 3.0$ $NK = 0.3052$ $XTB = 1.5$ $BR = 11.49$ $ISC = 19.9\text{ f}$
 + $NC = 1.88$ $IKR = 10.75$ $RC = 0.3567$ $CJC = 11.02\text{ p}$ $VJC = 0.3869$ $MJC = 0.3292$
 + $FC = 0.5$ $CJE = 29.31\text{ p}$ $VJE = 0.9036$ $MJE = 0.4101$ $TR = 38.32\text{ n}$ $TF = 361.8\text{ p}$
 + $ITF = 5.282$ $XTF = 249.9$ $VTF = 10$)

*1. Microsemi Corp. claims no responsibility for misapplication of Spice Model information. Spice modeling should be used as a precursor guide to in-circuit performance. Actual performance is the responsibility of the user/designer.



TO 18 CASE OUTLINE



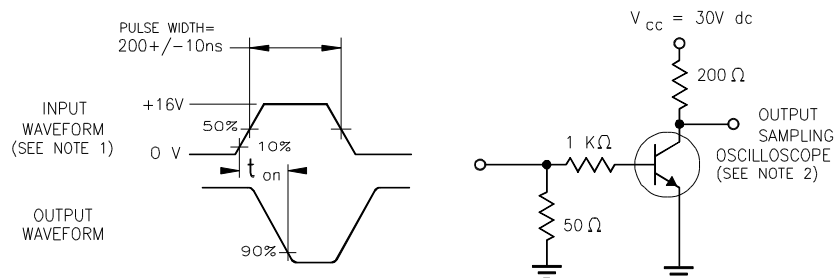
DIE CHARACTERISTICS

Back is Collector

Chip Thickness is:
10 MILS TYP

Metalization is:
Top = Al, Back = Au

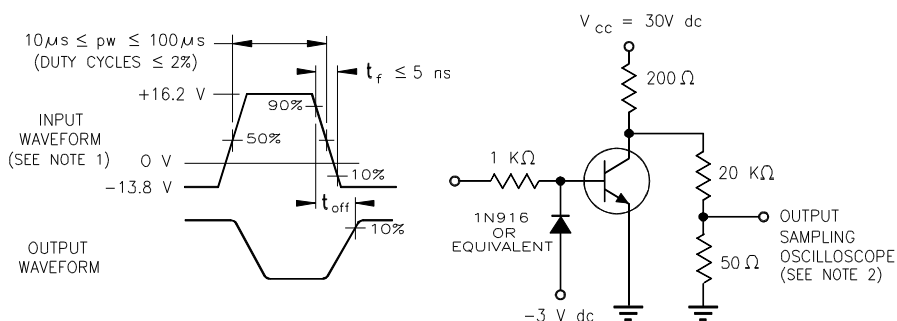
DIE OUTLINE



NOTES:

1. The rise time (t_r) of the applied pulse shall be $\leq 2.0 \text{ ns}$, duty cycle ≤ 2 percent, and the generator source impedance shall be 50 ohms.
2. Sampling oscilloscope: $Z_{in} \leq 100 \text{ K ohms}$, $C_{in} \leq 12 \text{ pF}$, rise time $\leq 5 \text{ ns}$.

FIGURE 1 Saturated Turn-on Time Test Circuit



NOTES:

1. The rise time (t_r) of the applied pulse shall be $\leq 2.0 \text{ ns}$, duty cycle ≤ 2 percent, and the generator source impedance shall be 50 ohms.
2. Sampling oscilloscope: $Z_{in} \leq 100 \text{ K ohms}$, $C_{in} \leq 12 \text{ pF}$, rise time $\leq 5 \text{ ns}$.

FIGURE 2 Saturated Turn-off Time Test Circuit

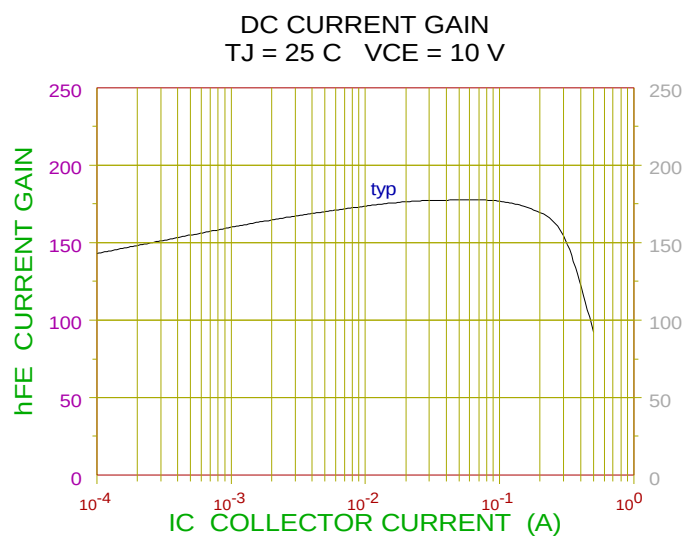


FIGURE 3

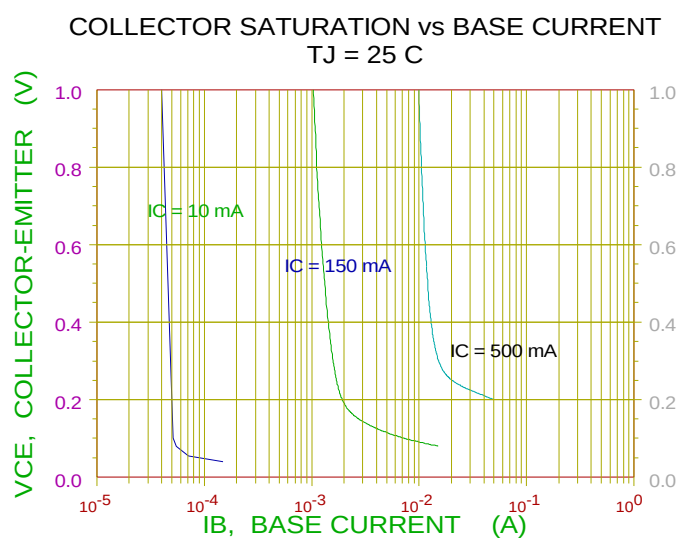


FIGURE 4

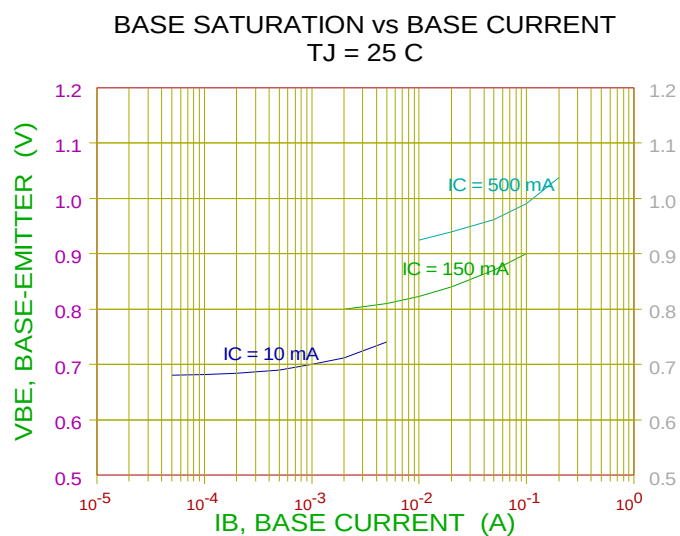


FIGURE 5

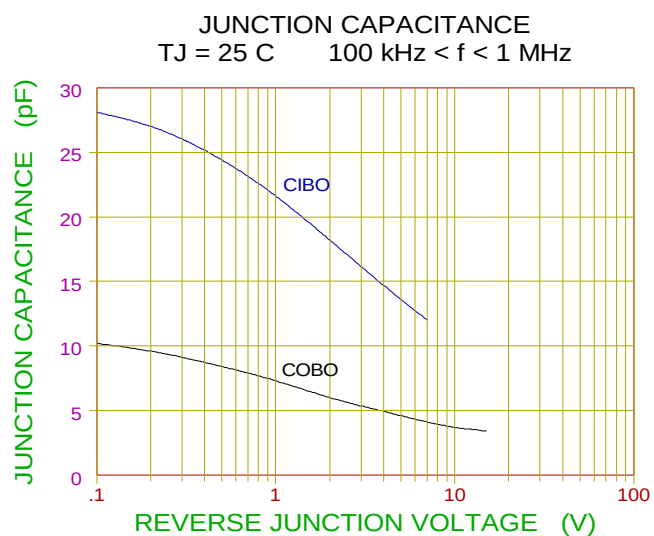


FIGURE 6

SMALL SIGNAL CURENT GAIN vs COLLECTOR CURRENT
 $T_J = 25^\circ\text{C}$ $V_{CE} = 10\text{ V}$ $f = 1\text{ kHz}$

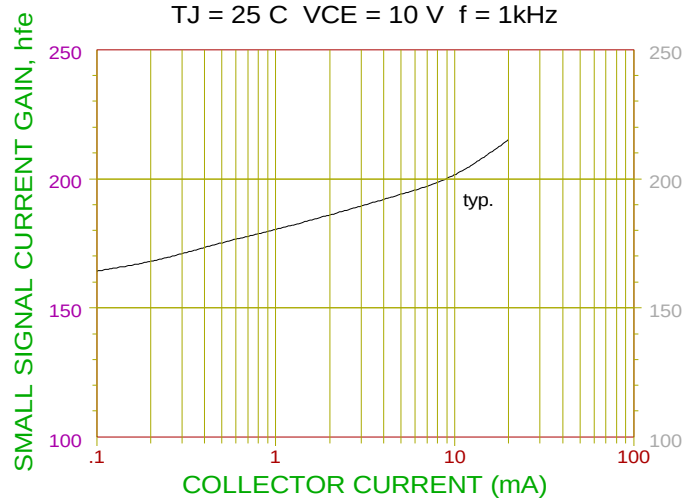


FIGURE 7

HIGH FREQUENCY GAIN
 $T_J = 25^\circ\text{C}$ $V_{CE} = 20\text{ V}$ $f = 100\text{ MHz}$

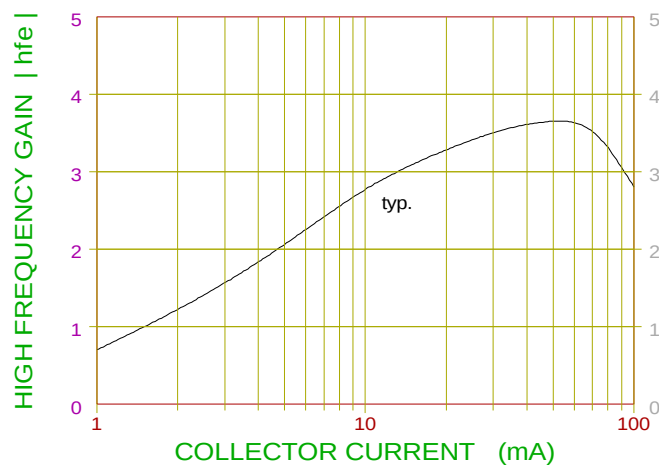


FIGURE 8

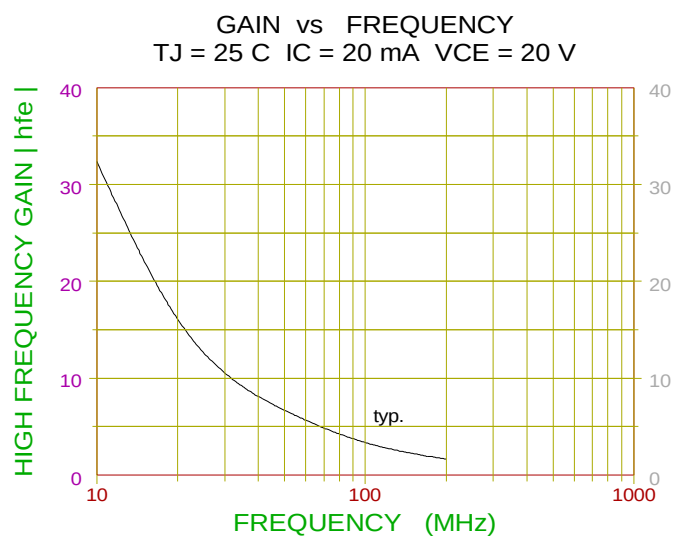


FIGURE 9